RBP321015-NASC2

Dual Wavelength SMD Type Emitter

Features

- Side view 1204 package
- Viewing Angle = $\pm 65^0$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Dual dominant wavelength (R=622nm , B=470nm)
- RoHS compliance

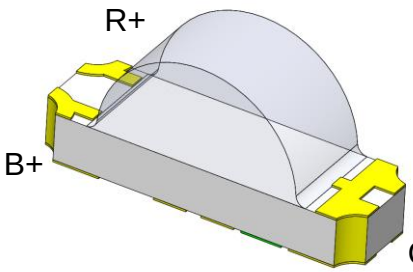
Description

The RBP321015-NASC2 is a double LED housed in a miniature SMD package. The device has a dominant wavelength of 622 nm and 470 nm LED.

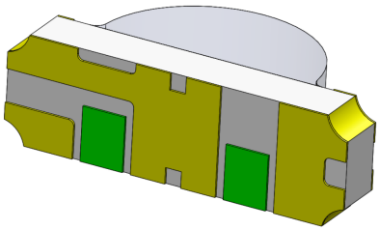
Applications

- Optical indicator.
- Switch and Symbol Display.

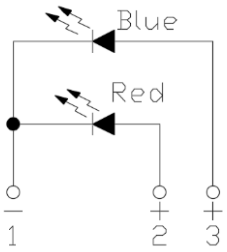
Package Outline



Common Cathode



Schematic



Absolute Maximum Rating at 25^{0}C

Symbol	*Parameters*		*Ratings*	*Units*	*Notes*
I_F	Continuous Forward Current	R	25	mA	
		B	25		
I_{FP}	Peak Forward Current	R	60	mA	
		B	60		
V_R	Reverse Voltage		5	V	
T_{opr}	Operating Temperature		-40 ~ +85	^{0}C	
T_{stg}	Storage Temperature		-40 ~ +100	^{0}C	
T_{sol}	Soldering Temperature		260	^{0}C	
P_D	Power Dissipation at(or below) 25℃ Free Air Temperature	R	60	mW	
		B	95		

Electro-Optical Characteristics *TA = 25°C (unless otherwise specified)*

Optical Characteristics (Red)

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
Iv	Luminous Intensity	I_F=20mA	57	-	140	mcd	
λp	Peak Wavelength	I_F=20mA	-	632	-	nm	
λ_D	Dominant Wavelength	I_F=20mA	-	622	-	nm	
θ1/2	Angle of Half Intensity	I_F=20mA	-	±65	-	deg	

Electrical Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
V_F	Forward Voltage	I_F=20mA	1.7	-	2.4	V	
I_R	Reverse Current	V_R=5V	-	-	1	μA	

Optical Characteristics (Blue)

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
Iv	Luminous Intensity	I_F=20mA	112	-	285	mcd	
λp	Peak Wavelength	I_F=20mA	-	466	-	nm	
λ_D	Dominant Wavelength	I_F=20mA	460	-	475	nm	
θ1/2	Angle of Half Intensity	I_F=20mA	-	±65	-	deg	

Electrical Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
V_F	Forward Voltage	I_F=20mA	2.6	-	3.3	V	
I_R	Reverse Current	V_R=5V	-	-	1	μA	

Notes:

The products are sensitive to staic electricity and must be carefully taken when hadling products.

Typical Characteristic Curves

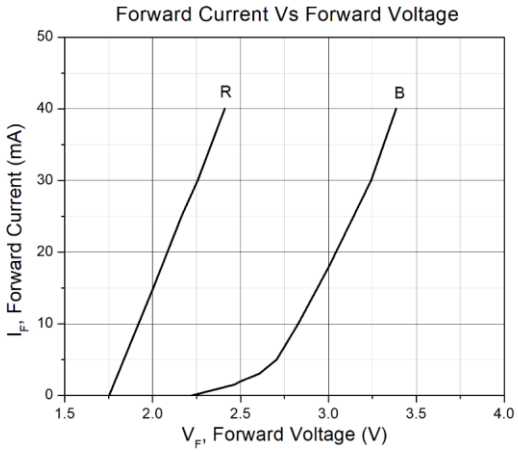


Figure 1

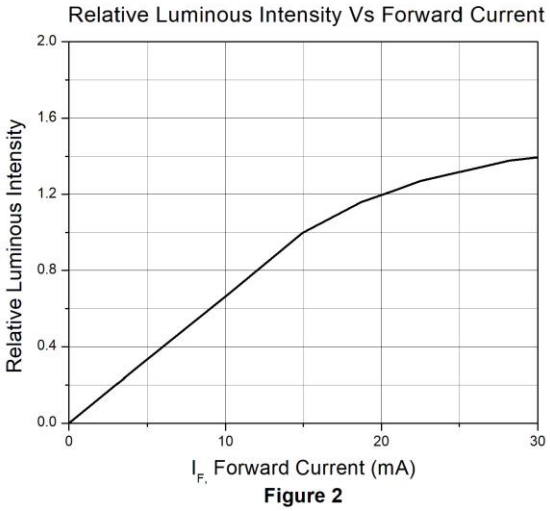


Figure 2

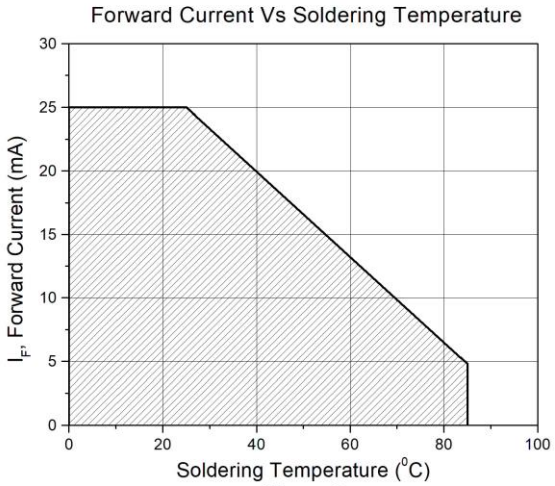


Figure 3

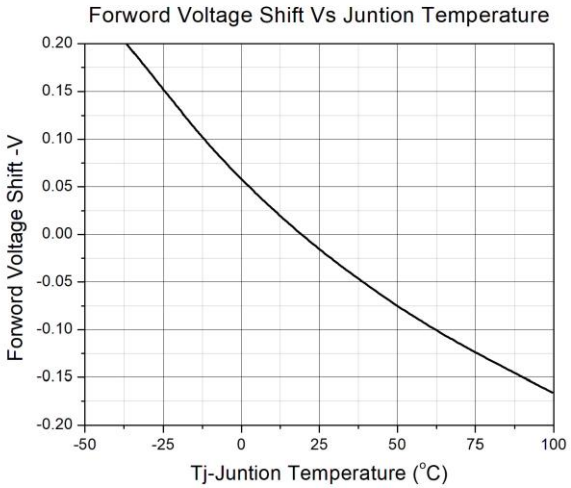


Figure 4

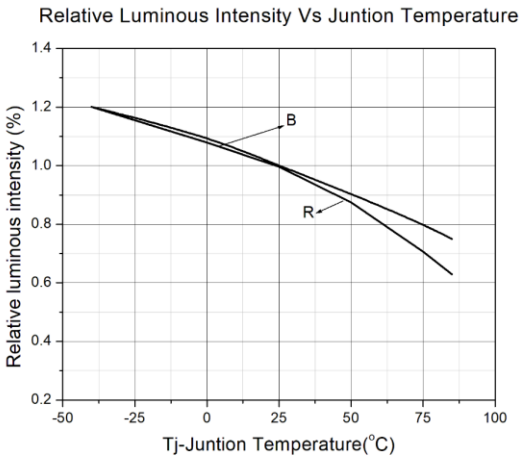


Figure 5

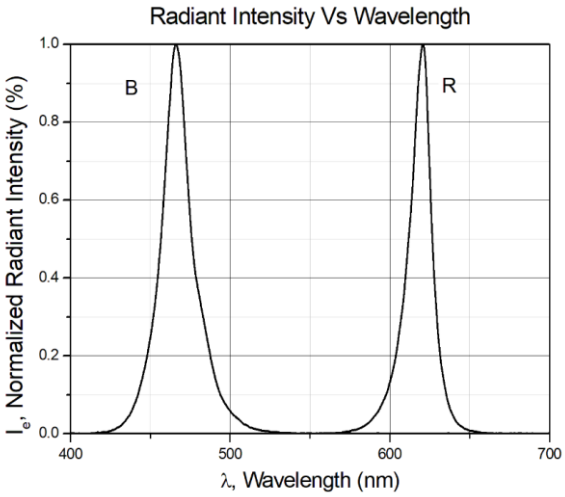


Figure 6

Typical Characteristic Curves

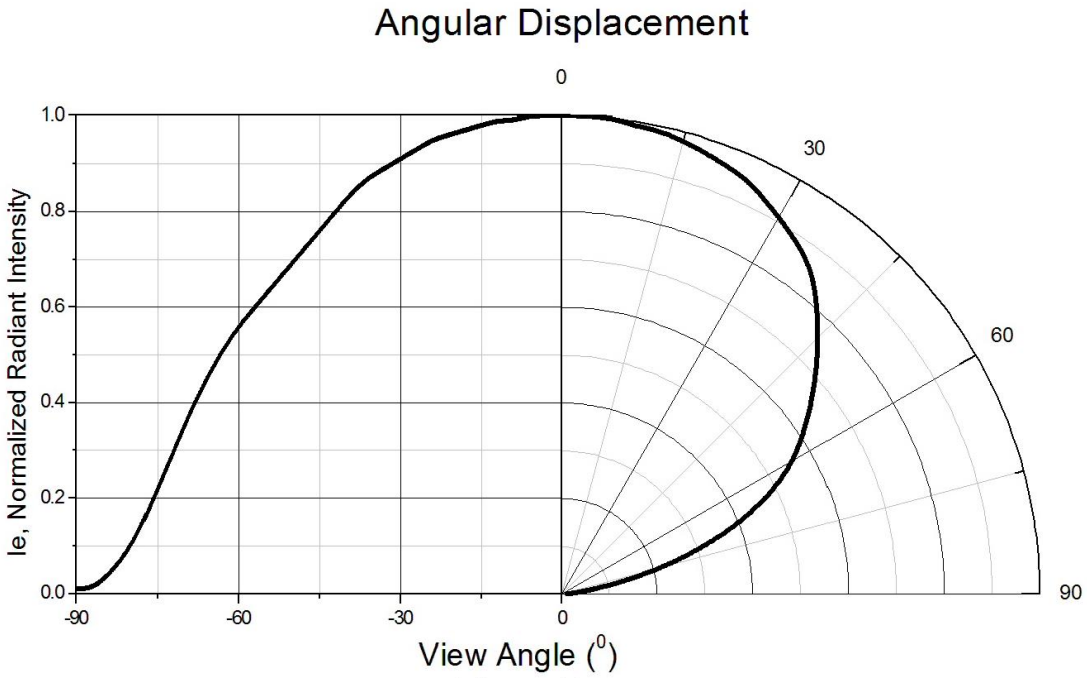
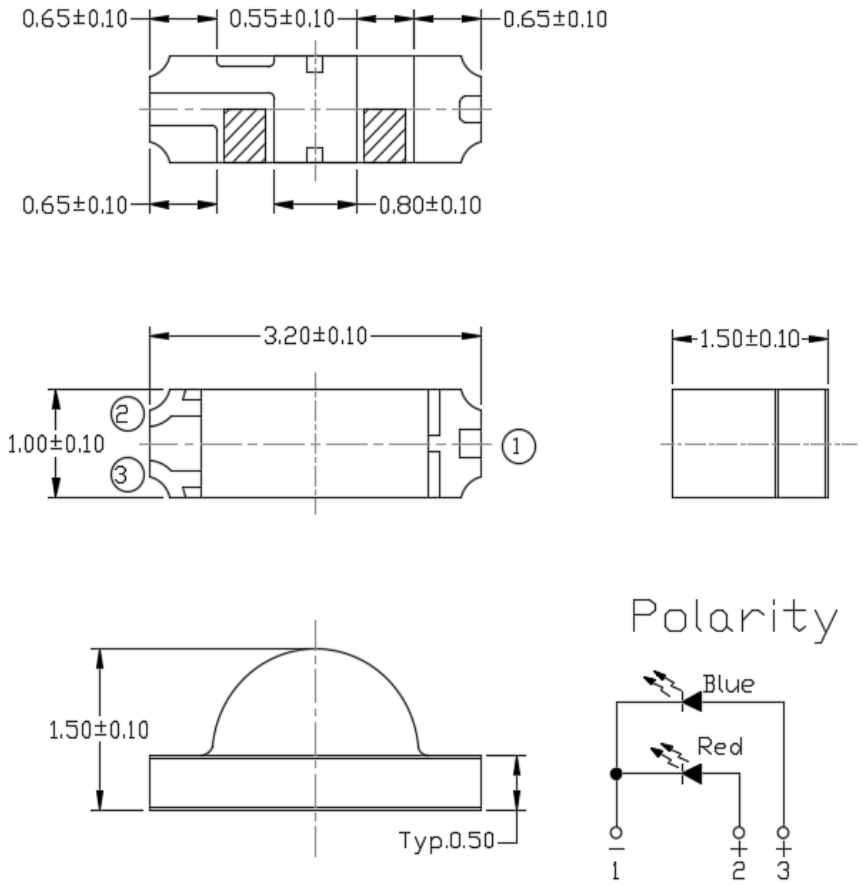


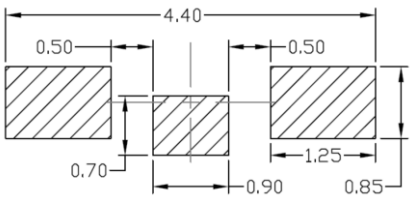
Figure 7

Package Dimension *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask *All dimensions are in mm, unless otherwise stated*

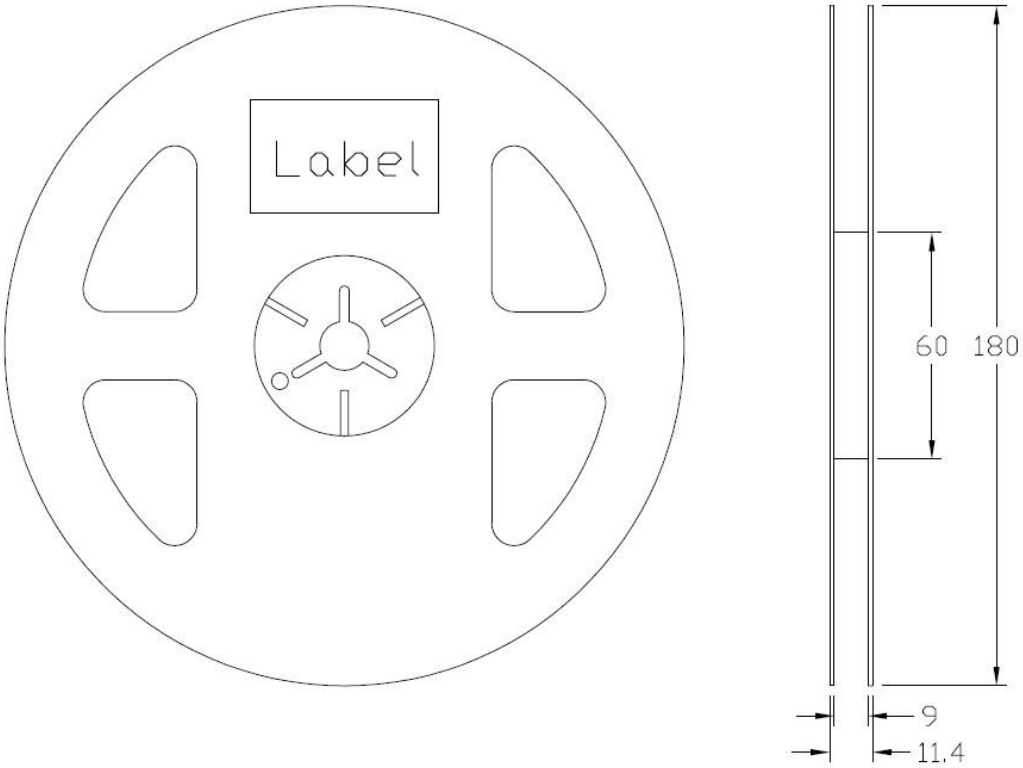


Note: Tolerance unless mentioned is ±0.1mm.

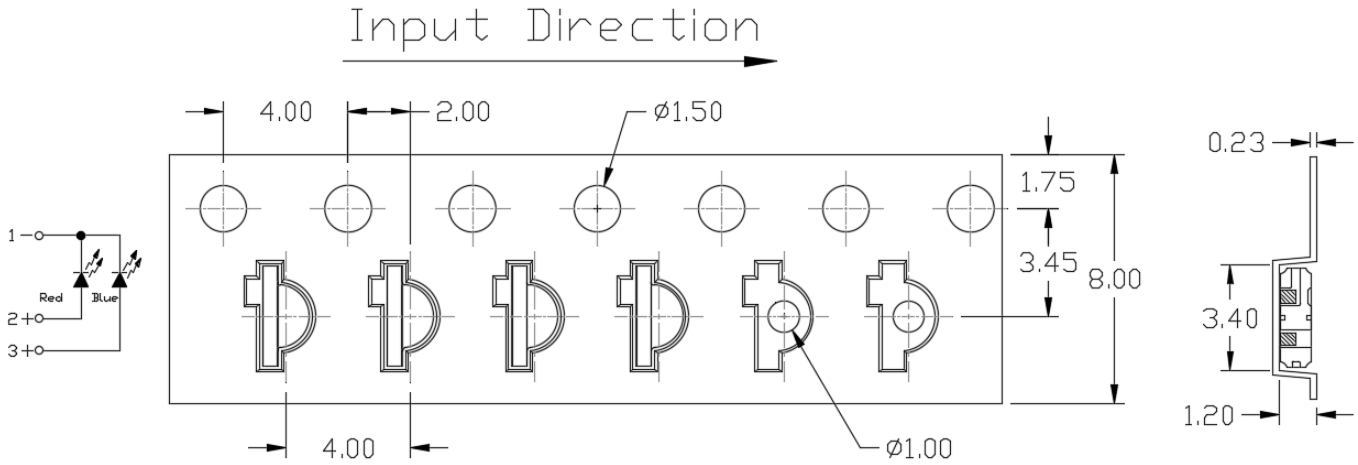
Ordering Information

Part Number	*Description*	*Quantity*
RBP321015-NASC2	Tape & Reel	2000 pcs

Reel Dimension *All dimensions are in mm, unless otherwise stated*

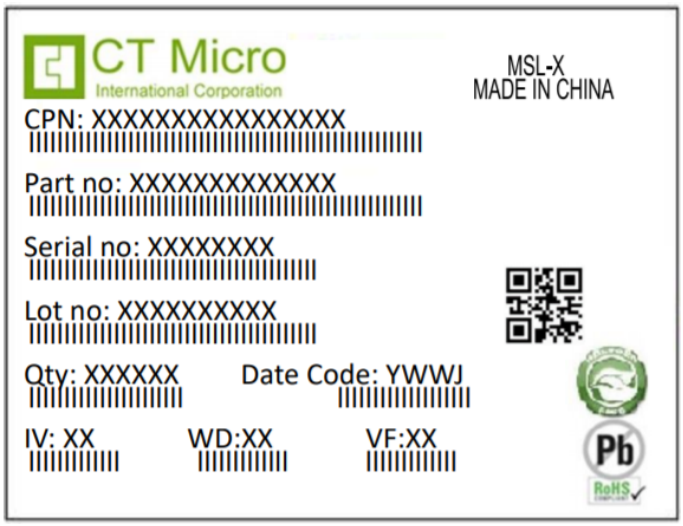


Tape Dimension *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ±0.1mm.

Label Form Specification



CPN : Customer Part Number

Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV : Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

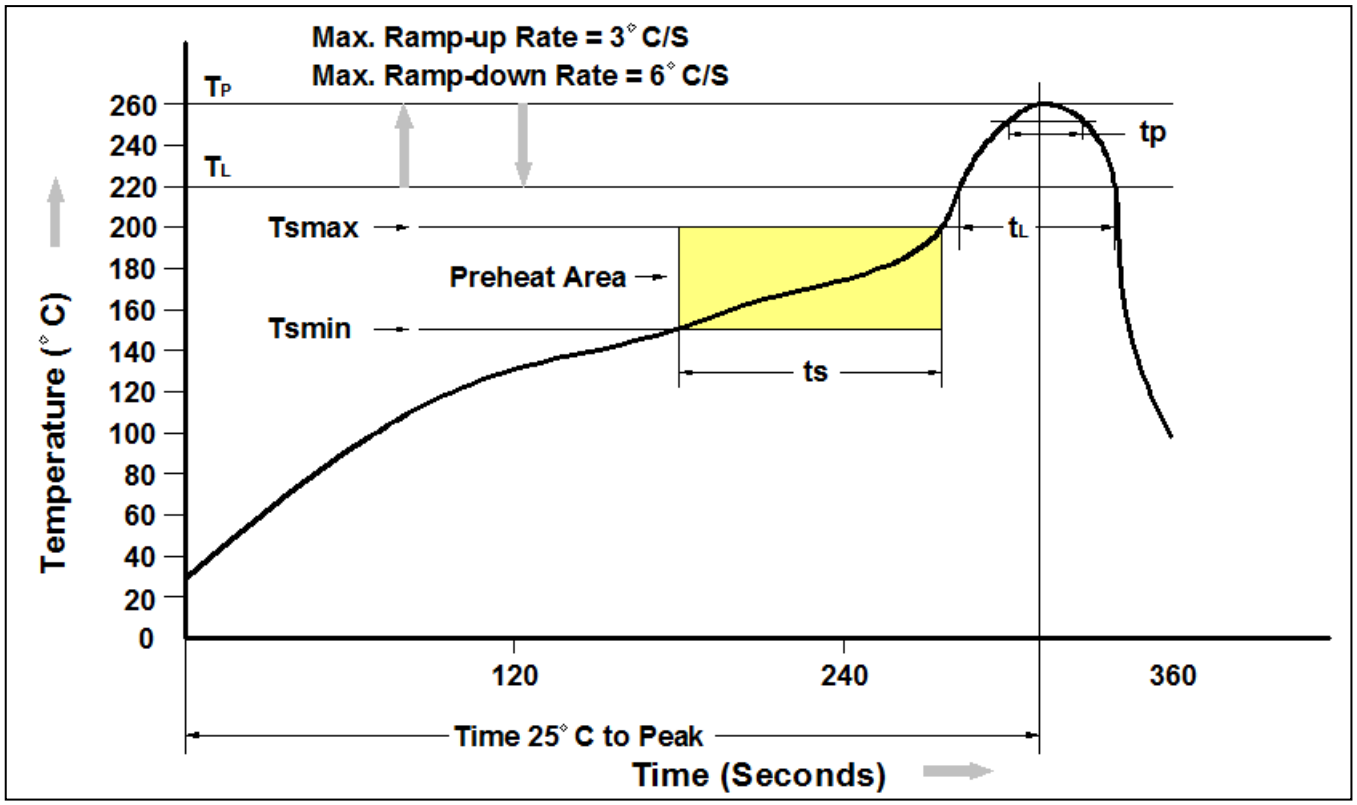
VF : Bin Code of Forward Voltage

MADE IN CHINA: Production Place

Storage Condition

1. Do not open moisture proof bag before the products are ready to use.
2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.

Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t_P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

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